

60V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _C = +25°C	
60V	$12m\Omega$ @ $V_{GS} = 10V$	70A	
007	$14m\Omega @ V_{GS} = 4.5V$	55A	

Features

- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low R_{DS(ON)} Minimizes Power Losses
- Low Q_G Minimizes Switching Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)), yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- High Frequency Switching
- Sync. Rectification
- DC-DC Converters

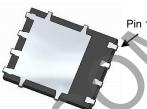
Mechanical Data

- Case: PowerDI®5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)

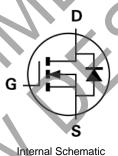


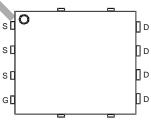
Top View





Bottom View





Top View Pin Configuration

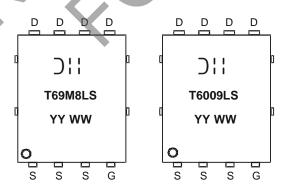
Ordering Information (Note 4)

-			
	Part Number	Case	Packaging
	DMT69M8LPS-13	PowerDI5060-8	2,500/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



⊃¦¦= Manufacturer's Marking T69M8LS & T6009LS = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 16 = 2016) WW = Week (01 to 53)



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DMT69M8LPS

Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	60	V
Gate-Source Voltage	V _{GSS}	±16	V
Continuous Drain Current (Note 5)	ID	10.2 8.2	Α
Continuous Drain Current (Note 6)	I _D	70 55	А
Maximum Continuous Body Diode Forward Current (Note 6)	I _S	100	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	160	Α
Avalanche Current, L = 0.1mH	I _{AS}	20.3	Α
Avalanche Energy, L = 0.1mH	E _{AS}	20.6	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	P_{D}	2.3	W
Thermal Resistance, Junction to Ambient (Note 5)		R _{0JA}	53	°C/W
Total Power Dissipation (Note 6)	$T_{C} = +25^{\circ}C$	P_{D}	113	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	1.1	°C/W
Operating and Storage Temperature Range		$T_{J,}T_{STG}$	-55 to +150	°C

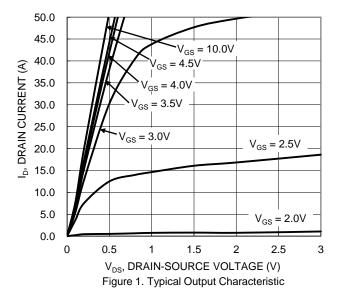
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	60	l		٧	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	1	l	±100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	0.7		2	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance	D-	_	9.8	12	mΩ	$V_{GS} = 10V, I_D = 13.5A$	
Static Drain-Source Off-Resistance	R _{DS(ON)}	_	12	14	11122	$V_{GS} = 4.5V, I_D = 11.5A$	
Diode Forward Voltage	V_{SD}		0.9	_	٧	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}		1,925	_		V 20V V 20V	
Output Capacitance	Coss		438		pF	$V_{DS} = 30V$, $V_{GS} = 0V$, $f = 1MHz$	
Reverse Transfer Capacitance	C _{rss}	_	41	_			
Gate Resistance	R_{G}		1.7		Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 10V)	Q_{G}	_	33.5	_			
Total Gate Charge (V _{GS} = 4.5V)	Q_{G}	_	15.6	_	nC	V 20V I 12.5A	
Gate-Source Charge	Q_GS	_	4.7	_	IIC	$V_{DS} = 30V, I_{D} = 13.5A$	
Gate-Drain Charge	Q_{GD}	_	5.3	_			
Turn-On Delay Time	t _{D(ON)}		4.5		V _{DD} = 30V, V _{GS} = 10V,		
Turn-On Rise Time	t _R	_	8.6	_			
Turn-Off Delay Time	t _{D(OFF)}	_	35.9	_	ns	$R_G = 6\Omega$, $I_D = 13.5A$	
Turn-Off Fall Time	t _F	_	15.7	_			
Body Diode Reverse Recovery Time	t _{RR}	_	18.2	_	ns	1 40.54 41/41 4004/	
Body Diode Reverse Recovery Charge	Q _{RR}	_	33.1	_	nC	$I_F = 13.5A$, di/dt = 400A/ μ s	

Notes:

- Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
 Thermal resistance from junction to soldering point (on the exposed drain pad).
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.





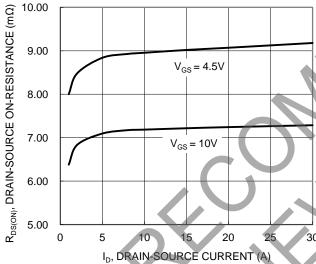


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

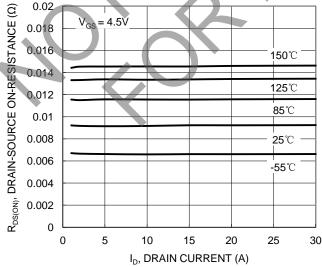


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

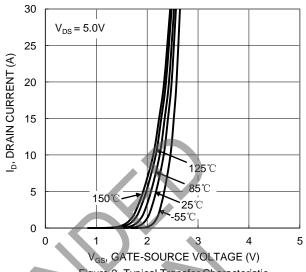


Figure 2. Typical Transfer Characteristic

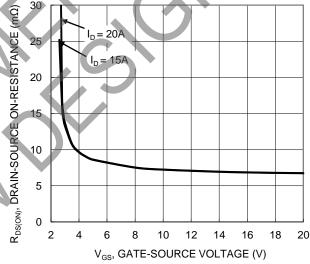


Figure 4. Typical Transfer Characteristic

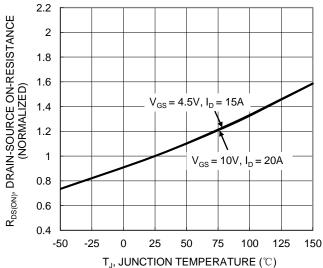


Figure 6. On-Resistance Variation with Temperature



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DMT69M8LPS

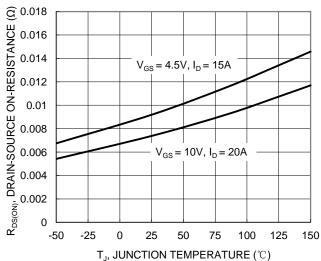


Figure 7. On-Resistance Variation with Temperature

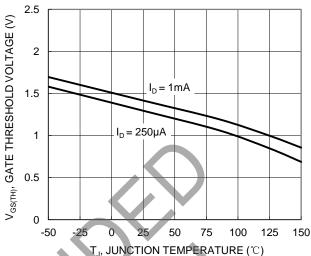
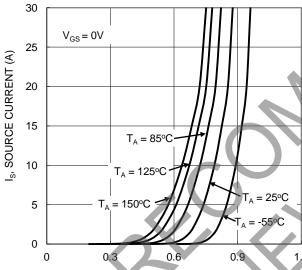


Figure 8. Gate Threshold Variation vs. Junction Temperature

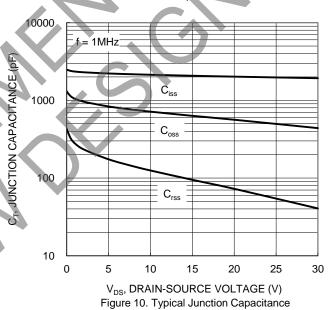


V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current

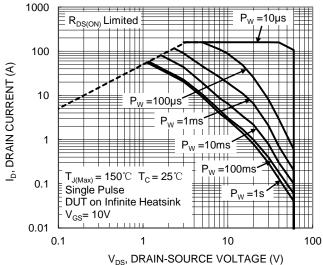
 $V_{DS} = 30V, I_{D} = 13.5A$

21

28



35



V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area

10

4

2

0

0

7

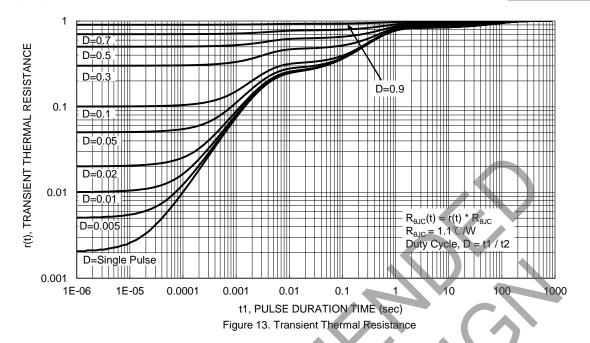
14

 Q_q (nC)

Figure 11. Gate Charge

June 2018



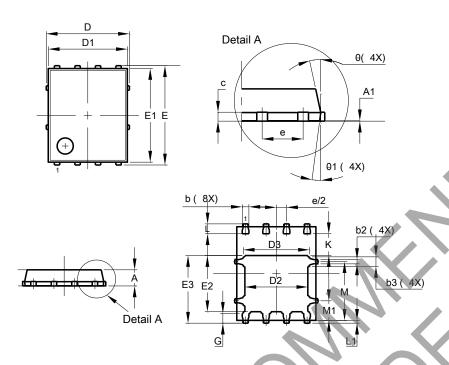




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8

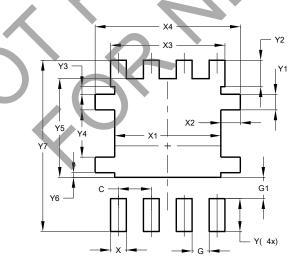


PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D	_	5.15 BSC	;		
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
E	6	6.15 BSC	,		
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
K_	0.51	_	_		
L	0.51	0.71	0.61		
11	0.100	0.200	0.175		
M	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
θ	10°	12°	11°		
01	6°	8°	7°		
▲ All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8



Dimensions	Value (in mm)			
С	1.270			
G	0.660			
G1	0.820			
Х	0.610			
X1	4.100			
X2	0.755			
Х3	4.420			
X4	5.610			
Υ	1.270			
Y1	0.600			
Y2	1.020			
Y3	0.295			
Y4	1.825			
Y5	3.810			
Y6	0.180			
Y7	6.610			



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DMT69M8LPS

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